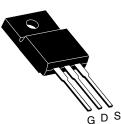


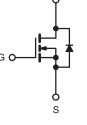


E Series Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	700)
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.18
Q _g max. (nC)	110)
Q _{gs} (nC)	15	
Q _{gd} (nC)	32	
Configuration	Sing	le

TO-220 FULLPAK





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFROMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF22N65E-E3
Lead (Pb)-free and Halogen-free	SiHF22N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	650	v
Gate-Source Voltage			V _{GS}	± 30	v
Continuous Durin Current (T. 150 °C)	V at 10.V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		22	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	ID	14	А
Pulsed Drain Current ^a			I _{DM}	56	
Linear Derating Factor				1.8	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	691	mJ
Maximum Power Dissipation			PD	35	W
Operating Junction and Storage Temperature Range	e		T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	$T_J = 1$	125 °C	-1) (/-1+	70	Mar
Reverse Diode dV/dt d	•		dV/dt	26	V/ns
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 7$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

S15-0291-Rev. B, 23-Feb-15

Document Number: 91537



RoHS



PARAMETER	SYMBOL	TYP.	MAX	•		UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	- 65				
Maximum Junction-to-Case (Drain)	R _{thJC}	-	3.6			°C/W	
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C_{,}$	inless otherw	ise noted)					
PARAMETER	SYMBOL	1	T CONDITIONS	MIN.	TYP.	MAX.	UNI
Static				1			
Drain-Source Breakdown Voltage	V _{DS}	VGS	= 0 V, I _D = 250 µA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	0.0	e to 25 °C, I _D = 1 mA	-	0.74	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 250 μA	2	-	4	V
	GO(III)		$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
			= 650 V, V _{GS} = 0 V	-	-	1	μA
Zero Gate Voltage Drain Current	I _{DSS}		∕, V _{GS} = 0 V, T _J = 125 °C	-	-	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 11 A	-	0.15	0.18	Ω
Forward Transconductance	g _{fs}	V _D	_S = 8 V, I _D = 5 A	-	6.7	-	S
Dynamic		•			•		
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	2415	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	-	118	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	4	-	− □ pF
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 520 V, $V_{GS} = 0 V$		-	89	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	307	-	
Total Gate Charge	Qg			-	73	110	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 11 A, V _{DS} = 520 V		15	-	nC
Gate-Drain Charge	Q _{gd}			-	32	-	1
Turn-On Delay Time	t _{d(on)}			-	22	45	
Rise Time	t _r	V _{DD} =	= 520 V, I _D = 11 A,	-	33	66	ns
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	= 10 V, R _g = 9.1 Ω	-	73	110	
Fall Time	t _f	1		-	38	76	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.64	-	Ω
Drain-Source Body Diode Characterist	cs						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22	
Pulsed Diode Forward Current	I _{SM}			-	-	56	A
Diode Forward Voltage	V _{SD}	T _J = 25 °0	C, I _S = 11 A, V _{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	400	-	ns
Reverse Recovery Charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 11 A, dl/dt = 100 A/μs, V _B = 400 V		-	5.9	-	μC
Reverse Recovery Current	I _{RRM}	ui/dt =	$100 Av \mu s, v_R = 400 V$	-	20	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

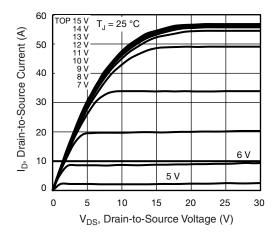


Fig. 1 - Typical Output Characteristics

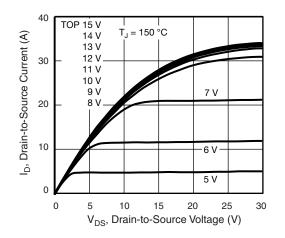
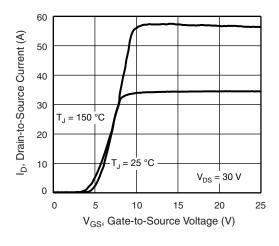


Fig. 2 - Typical Output Characteristics





3 On Resistance (Normalized) 2.5 R_{DS(on)}, Drain-to-Source 2 1.5 10 V 1 V_{GS} = 0.5 0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

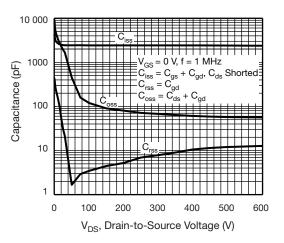


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

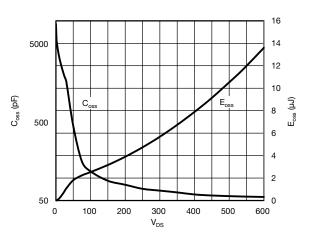


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

S15-0291-Rev. B, 23-Feb-15

3

Document Number: 91537

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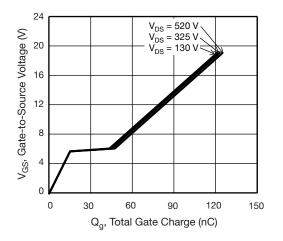


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

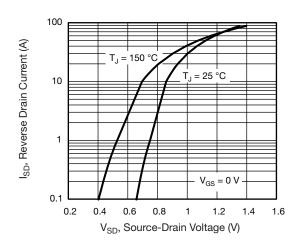


Fig. 8 - Typical Source-Drain Diode Forward Voltage

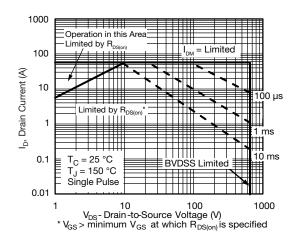


Fig. 9 - Maximum Safe Operating Area

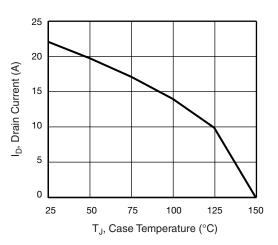


Fig. 10 - Maximum Drain Current vs. Case Temperature

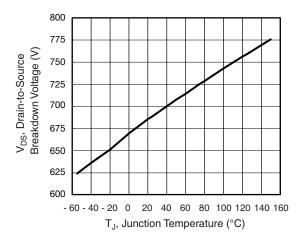
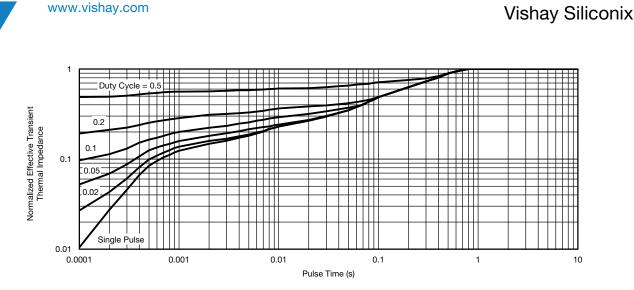


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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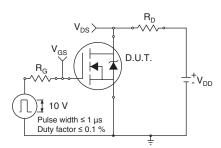


Fig. 13 - Switching Time Test Circuit

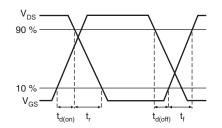


Fig. 14 - Switching Time Waveforms

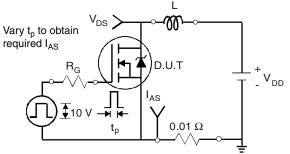


Fig. 15 - Unclamped Inductive Test Circuit

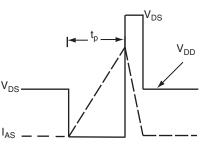


Fig. 16 - Unclamped Inductive Waveforms

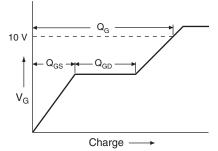
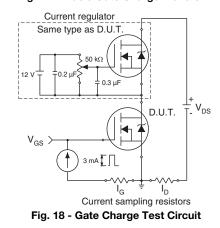


Fig. 17 - Basic Gate Charge Waveform



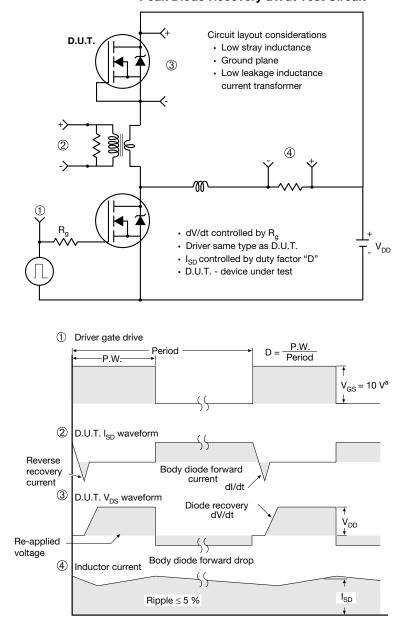
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Peak Diode Recovery dV/dt Test Circuit



Note

a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

1



OPTION 2: FACILITY CODE = Y



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100) BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1st character located at the 2nd row of the unit marking

2

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